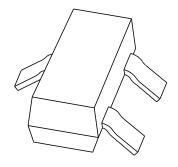
#### DISCRETE SEMICONDUCTORS

# DATA SHEET



## BAV199 Low-leakage double diode

Product specification Supersedes data of June 1994 File under Discrete Semiconductors, SC01 1996 Mar 13





## Low-leakage double diode

#### **BAV199**

#### **FEATURES**

- Plastic SMD package
- Low leakage current: typ. 3 pA
- Switching time: typ. 0.8 μs
- Continuous reverse voltage: max. 75 V
- Repetitive peak reverse voltage: max. 85 V
- Repetitive peak forward current: max. 500 mA.

#### **APPLICATION**

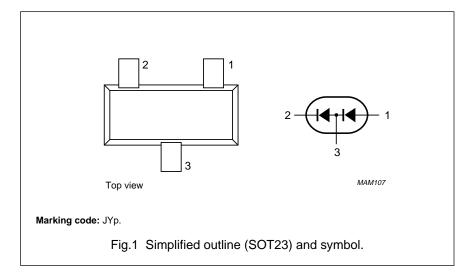
• Low-leakage current applications in surface mounted circuits.

#### **DESCRIPTION**

Epitaxial, medium-speed switching, double diode in a small plastic SOT23 SMD package. The diodes are connected in series.

#### **PINNING**

| PIN | DESCRIPTION    |
|-----|----------------|
| 1   | anode          |
| 2   | cathode        |
| 3   | anode; cathode |



#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL           | PARAMETER                           | CONDITIONS                                           | MIN. | MAX. | UNIT |
|------------------|-------------------------------------|------------------------------------------------------|------|------|------|
| Per diode        | Per diode                           |                                                      |      |      |      |
| V <sub>RRM</sub> | repetitive peak reverse voltage     |                                                      | _    | 85   | V    |
| V <sub>R</sub>   | continuous reverse voltage          |                                                      | _    | 75   | V    |
| I <sub>F</sub>   | continuous forward current          | single diode loaded; see Fig.2; note 1               | _    | 160  | mA   |
|                  |                                     | double diode loaded; see Fig.2; note 1               | -    | 140  | mA   |
| I <sub>FRM</sub> | repetitive peak forward current     |                                                      | _    | 500  | mA   |
| I <sub>FSM</sub> | non-repetitive peak forward current | square wave; $T_j = 25$ °C prior to surge; see Fig.4 |      |      |      |
|                  |                                     | $t_p = 1 \mu s$                                      | _    | 4    | Α    |
|                  |                                     | t <sub>p</sub> = 1 ms                                | _    | 1    | Α    |
|                  |                                     | t <sub>p</sub> = 1 s                                 | _    | 0.5  | Α    |
| P <sub>tot</sub> | total power dissipation             | T <sub>amb</sub> = 25 °C; note 1                     | 1    | 250  | mW   |
| T <sub>stg</sub> | storage temperature                 |                                                      | -65  | +150 | °C   |
| Tj               | junction temperature                |                                                      | _    | 150  | °C   |

#### Note

1. Device mounted on a FR4 printed-circuit board.

## Low-leakage double diode

**BAV199** 

#### **ELECTRICAL CHARACTERISTICS**

 $T_i = 25$  °C unless otherwise specified.

| SYMBOL          | PARAMETER             | CONDITIONS                                                                                                                                        | TYP.  | MAX. | UNIT |  |
|-----------------|-----------------------|---------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|------|--|
| Per diode       | Per diode             |                                                                                                                                                   |       |      |      |  |
| V <sub>F</sub>  | forward voltage       | see Fig.3                                                                                                                                         |       |      |      |  |
|                 |                       | I <sub>F</sub> = 1 mA                                                                                                                             | _     | 900  | mV   |  |
|                 |                       | I <sub>F</sub> = 10 mA                                                                                                                            | _     | 1000 | mV   |  |
|                 |                       | I <sub>F</sub> = 50 mA                                                                                                                            | _     | 1100 | mV   |  |
|                 |                       | I <sub>F</sub> = 150 mA                                                                                                                           | _     | 1250 | mV   |  |
| I <sub>R</sub>  | reverse current       | see Fig.5                                                                                                                                         |       |      |      |  |
|                 |                       | V <sub>R</sub> = 75 V                                                                                                                             | 0.003 | 5    | nA   |  |
|                 |                       | V <sub>R</sub> = 75 V; T <sub>j</sub> = 150 °C                                                                                                    | 3     | 80   | nA   |  |
| C <sub>d</sub>  | diode capacitance     | $f = 1 \text{ MHz}$ ; $V_R = 0$ ; see Fig.6                                                                                                       | 2     | _    | pF   |  |
| t <sub>rr</sub> | reverse recovery time | when switched from I <sub>F</sub> = 10 mA to I <sub>R</sub> = 10 mA; R <sub>L</sub> = 100 $\Omega$ ; measured at I <sub>R</sub> = 1 mA; see Fig.7 | 0.8   | 3    | μs   |  |

#### THERMAL CHARACTERISTICS

| SYMBOL               | PARAMETER                                     | CONDITIONS | VALUE | UNIT |
|----------------------|-----------------------------------------------|------------|-------|------|
| R <sub>th j-tp</sub> | thermal resistance from junction to tie-point |            | 360   | K/W  |
| R <sub>th j-a</sub>  | thermal resistance from junction to ambient   | note 1     | 500   | K/W  |

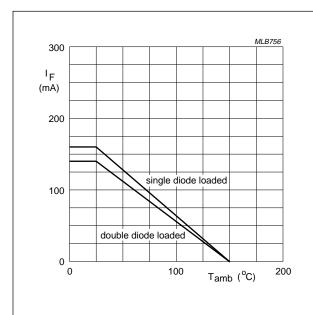
#### Note

1. Device mounted on a FR4 printed-circuit board.

## Low-leakage double diode

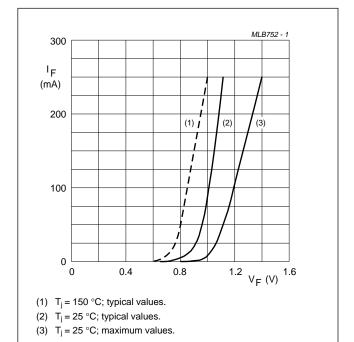
**BAV199** 

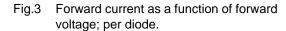
#### **GRAPHICAL DATA**

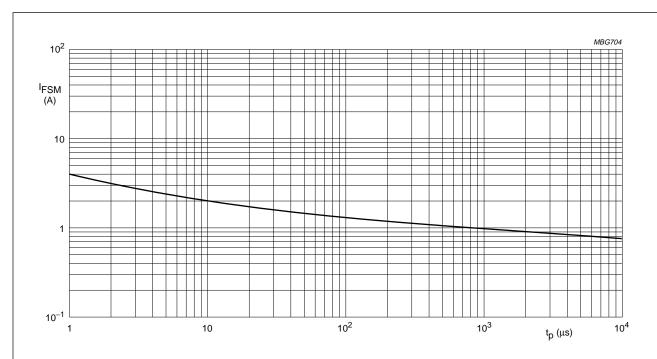


Device mounted on a FR4 printed-circuit board.

Fig.2 Maximum permissible continuous forward current as a function of ambient temperature.





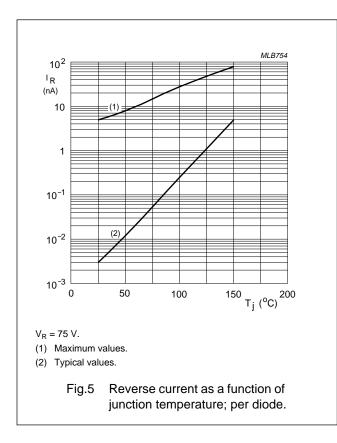


Based on square wave currents;  $T_j = 25$  °C prior to surge.

Fig.4 Maximum permissible non-repetitive peak forward current as a function of pulse duration per diode.

## Low-leakage double diode

**BAV199** 



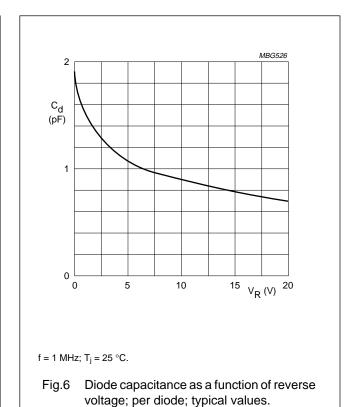
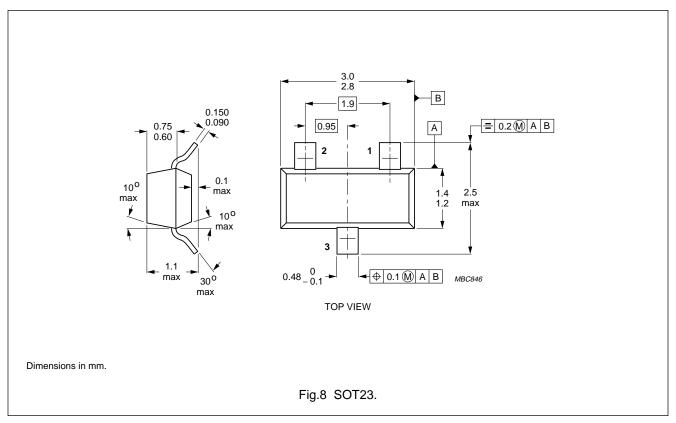


Fig.7 Reverse recovery time test circuit and waveforms.

### Low-leakage double diode

**BAV199** 

#### **PACKAGE OUTLINE**



#### **DEFINITIONS**

| Data Sheet Status                                                                                                                                                                                                                                                                                                                                                                                                                                         |                                                                                       |  |  |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|--|--|
| Objective specification                                                                                                                                                                                                                                                                                                                                                                                                                                   | This data sheet contains target or goal specifications for product development.       |  |  |
| Preliminary specification                                                                                                                                                                                                                                                                                                                                                                                                                                 | This data sheet contains preliminary data; supplementary data may be published later. |  |  |
| Product specification                                                                                                                                                                                                                                                                                                                                                                                                                                     | This data sheet contains final product specifications.                                |  |  |
| Limiting values                                                                                                                                                                                                                                                                                                                                                                                                                                           |                                                                                       |  |  |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. |                                                                                       |  |  |
| Application information                                                                                                                                                                                                                                                                                                                                                                                                                                   |                                                                                       |  |  |
| Where application information is given, it is advisory and does not form part of the specification.                                                                                                                                                                                                                                                                                                                                                       |                                                                                       |  |  |

#### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.